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List of Patents and Publications for Applicant's INFORMATION DISCLOSURE STATEMENT			Applicant BRETT LOW	Applicant BRETT LOWE ET AL.				
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My	C40	Co-pending United States Patent Application Serial No. 09/918,364 filed July 30, 2001 (ZILG:518/ZILO:002) which is relied upon by the present application for an earlier effective filing date under 35 U.S.C. Section 120					